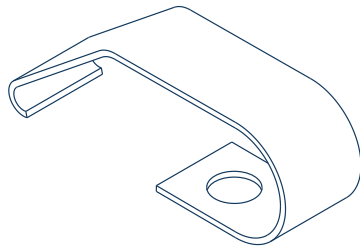




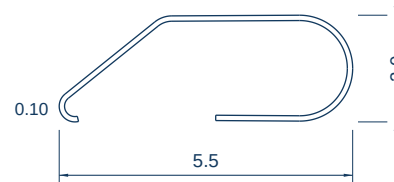
Type 6-01 B601-15055020

SMD EMI Spring Contact | Beryllium Copper | Units: mm

Isometric



Front view (mm)



Top view (mm)



MECHANICAL

VALUE

Thickness	0.10 mm
Width	1.5 mm +/- 0.2
Length	5.5 mm +/- 0.2
Height	2.0 mm +/- 0.2
Form	base tongue, 180 deg end loop, top plate, sloping web, return hook
Base tongue	1.57 mm flat SMD land
End loop	R0.941 / R0.944 CL, 181 deg total
Top plate / web	2.39 mm flat + 2.16 mm at 38 deg (R0.469 CL shoulder)
Return hook	R0.244 CL, 155 deg
Base hole	dia 0.78 mm at 3.73 mm from the hook end, on the width centreline
Developed length	10.06 mm
Material / plating	BeCu, Gold-plated (G)
Volume / mass	1.461 mm ³ 12.2 mg (BeCu)

PRODUCT DATA

VALUE

Mfr P/N	B601-15055020G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 5.5x1.5x2.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-6-01.html
File format	STEP AP214